# Ultra High Accuracy, Low Iq, 500 mA Low Dropout Regulator

The NCP3335A is a high performance, low dropout regulator. With accuracy of  $\pm 0.9\%$  over line and load and ultra–low quiescent current and noise it encompasses all of the necessary features required by today's consumer electronics. This unique device is guaranteed to be stable without a minimum load current requirement and stable with any type of capacitor as small as 1.0  $\mu F$ . The NCP3335A also comes equipped with sense and noise reduction pins to increase the overall utility of the device. The NCP3335A offers reverse bias protection.

#### **Features**

- High Accuracy Over Line and Load (±0.9% at 25°C)
- Ultra-Low Dropout Voltage at Full Load (260 mV typ.)
- No Minimum Output Current Required for Stability
- $\bullet~$  Low Noise (35  $\mu Vrms~w/10~nF~C_{nr}$  and 56  $\mu Vrms~w/out~C_{nr})$
- Low Shutdown Current (0.07 μA)
- Reverse Bias Protected
- 2.6 V to 12 V Supply Range
- Thermal Shutdown Protection
- Current Limitation
- Requires Only 1.0 μF Output Capacitance for Stability
- Stable with Any Type of Capacitor (including MLCC)
- Available in 2.5 V, 2.85 V, 3.3 V, 5.0 V and Adjustable Output Voltages
- These are Pb-Free Devices

# **Applications**

- PCMCIA Card
- Cellular Phones
- Camcoders and Cameras
- Networking Systems, DSL/Cable Modems
- Cable Set-Top Box
- MP3/CD Players
- DSP Supply
- Displays and Monitors



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Micro8™ DM SUFFIX CASE 846A



DFN10 MN SUFFIX CASE 485C

#### **MARKING DIAGRAM**

	Fixed Version	Adj Version
8 8 8 8 8 8	Pin 1, 2. Vout	Pin 1, 2. Vout
	<ol><li>Sense</li></ol>	3. Adj
XXX	4. GND	4. GND
AYW•	5. NR	5. NR
	6. <del>SD</del>	6. <u>SD</u>
1 8888	7, 8. V <sub>in</sub>	7, 8. V <sub>in</sub>

		Fixed Version	Adj Version
1	O 3335A	Pin 1, 2. V <sub>out</sub> 3. Sense	Pin 1, 2. V <sub>out</sub> 3. Adj
	XXX	4. GND	3. Auj 4. GND
	ALYW=	5, 6. NC	5, 6. NC
	•	7. NR	7. NR
		8. <del>SD</del>	8. <u>SD</u>
		9. 10. Vin	9. 10. Vin

#### Micro8

# 25 V YYY =

ХХХ	= LIQ for 2.5 V	XXX	= 25 for 2.5 V
	= LIR for 2.85 V		= 285 for 2.85 V
	= LIS for 3.3 V		= 33 for 3.3 V
	= LIT for 5.0 V		= 50 for 5.0 V
	= LIO for Adj.		= ADJ for Adj.

A = Assembly Location

L = Wafer Lot
Y = Year
W = Work Week
• = Pb-Free Package

(Note: Microdot may be in either location)

## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 13 of this data sheet.

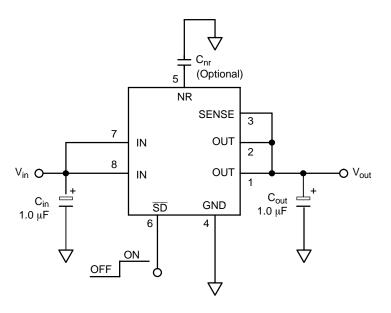


Figure 1. Typical Fixed Version Application Schematic (Micro8 Package)

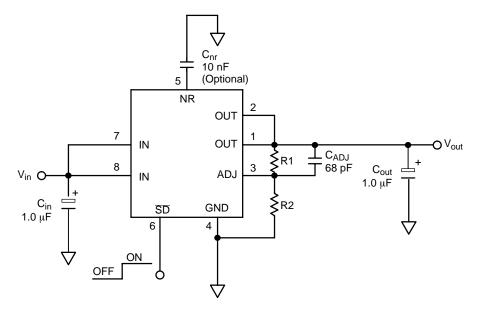


Figure 2. Typical Adjustable Version Application Schematic (Micro8 Package)

# **PIN FUNCTION DESCRIPTION**

#### **Fixed Version**

Micro8 Pin No.	DFN10 Pin No.	Pin Name	Description
1, 2	1, 2	V <sub>out</sub>	Regulated output voltage. Bypass to ground with $C_{out} \geq 1.0~\mu F$ .
3	3	SENSE	For output voltage sensing, connect to Pins 1 and 2.
4	4	GND	Power Supply Ground
5	7	NR	Noise Reduction Pin. This is an optional pin used to further reduce noise.
6	8	SD	Shutdown pin. When not in use, this pin should be connected to the input pin.
7, 8	9, 10	V <sub>in</sub>	Power Supply Input Voltage
-	5, 6	NC	Not Connected
_	EPAD	EPAD	Exposed thermal pad should be connected to ground.

# **Adjustable Version**

1, 2	1, 2	V <sub>out</sub>	Regulated output voltage. Bypass to ground with $C_{out} \geq 1.0 \ \mu F.$
3	3	Adj	Adjustable pin; reference voltage = 1.25 V.
4	4	GND	Power Supply Ground
5	7	NR	Noise Reduction Pin. This is an optional pin used to further reduce noise.
6	8	SD	Shutdown pin. When not in use, this pin should be connected to the input pin.
7, 8	9, 10	V <sub>in</sub>	Power Supply Input Voltage
-	5, 6	NC	Not Connected
-	EPAD	EPAD	Exposed thermal pad should be connected to ground.

# **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Input Voltage		-0.3 to +16	V
Output Voltage	V <sub>out</sub>	-0.3 to V <sub>in</sub> +0.3 or 10 V*	V
Shutdown Pin Voltage	V <sub>sh</sub>	-0.3 to +16	V
Thermal Characteristics Thermal Resistance, Junction-to-Air	$R_{ hetaJA}$	238	°C/W
Operating Junction Temperature Range, Micro8	TJ	-40 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-50 to+150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

NOTE: This device series contains ESD protection and exceeds the following tests:

Human Body Model (HBM) JESD 22-A114-B

Machine Model (MM) JESD 22-A115-A

\*Which ever is less. Reverse bias protection feature valid only if  $V_{out} - V_{in} \le 7 \text{ V}$ .

# THERMAL CHARACTERISTICS

	Test Conditions (Typical Value)				
Characteristic	Min Pad Board (Note 1)	1" Pad Board (Note 1)	Unit		
Micro 8	•				
Junction-to-Air, θJA	264	174	°C/W		
Junction-to-Pin, ψJL2	110	100	°C/W		
10 Lead DFN EPad	•				
Junction-to-Air, θJA	215	66	°C/W		
Junction-to-Pin, ψJL2	55	17	°C/W		

<sup>1.</sup> As mounted on a 35 x 35 x 1.5 mm FR4 Substrate, with a single layer of a specified copper area of 2 oz (0.07 mm thick) copper traces and heat spreading area. JEDEC 51 specifications for a low and high conductivity test board recommend a 2 oz copper thickness. Test conditions are under natural convection or zero air flow.

# $\textbf{ELECTRICAL CHARACTERISTICS - 2.5 V} \ (V_{out} = 2.5 \ V \ typical, \ V_{in} = 2.9 \ V, \ T_{A} = -40^{\circ}C \ to \ +85^{\circ}C, \ unless \ otherwise \ noted)$

Characteristic	Symbol	Min	Тур	Max	Unit
Output Voltage (Accuracy) $V_{in}$ = 2.9 V to 6.5 V, $I_{load}$ = 0.1 mA to 500 mA, $T_J$ = 25°C	V <sub>out</sub>	-0.9% 2.477	2.5	+0.9% 2.523	V
Output Voltage (Accuracy) $V_{in}$ = 2.9 V to 6.5 V, $I_{load}$ = 0.1 mA to 500 mA, $T_J$ = 0°C to +85°C	V <sub>out</sub>	-1.4% 2.465	2.5	+1.4% 2.535	V
Output Voltage (Accuracy), (Note 2) $V_{in}$ = 2.9 V to 6.5 V, $I_{load}$ = 0.1 mA to 500 mA, $T_J$ = -40°C to +150°C	V <sub>out</sub>	-1.5% 2.462	2.5	+1.5% 2.538	V
Line Regulation $V_{in} = 2.9 \text{ V to } 12 \text{ V}, I_{load} = 0.1 \text{ mA}$	Line <sub>Reg</sub>		0.04		mV/V
Load Regulation V <sub>in</sub> = 2.9 V, I <sub>load</sub> = 0.1 mA to 500 mA	Load <sub>Reg</sub>		0.04		mV/mA
Dropout Voltage (See App Note) $I_{load} = 500 \text{ mA (Note 3)}$ $I_{load} = 300 \text{ mA (Note 3)}$ $I_{load} = 50 \text{ mA}$ $I_{load} = 0.1 \text{mA}$	V <sub>DO</sub>			340 230 110 10	mV
Peak Output Current (See Figure 7)	I <sub>pk</sub>	500	700	800	mA
Short Output Current (See Figure 7)	I <sub>sc</sub>			900	mA
Thermal Shutdown	TJ		160		°C
Ground Current In Regulation I <sub>load</sub> = 500 mA (Note 3) I <sub>load</sub> = 300 mA (Note 3) I <sub>load</sub> = 50 mA I <sub>load</sub> = 0.1 mA	I <sub>GND</sub>		9.0 4.6 0.8	14 7.5 2.5 190	mA μA
In Dropout $V_{in} = 2.4 \text{ V}, I_{load} = 0.1 \text{ mA}$				500	μΑ
In Shutdown $S_D = 0 \text{ V}$	I <sub>GNDsh</sub>		0.07	1.0	μΑ
Output Noise $\begin{array}{l} C_{nr}=0 \text{ nF, } I_{load}=500 \text{ mA, } f=10 \text{ Hz to } 100 \text{ kHz, } C_{out}=10  \mu\text{F} \\ C_{nr}=10 \text{ nF, } I_{load}=500 \text{ mA, } f=10 \text{ Hz to } 100 \text{ kHz, } C_{out}=10  \mu\text{F} \end{array}$	V <sub>noise</sub>		56 35		μVrms μVrms
Shutdown Threshold Voltage ON Threshold Voltage OFF		2.0		0.4	V
$\overline{\text{SD}}$ Input Current, $V_{\text{SD}}$ = 0 V to 0.4 V or $V_{\text{SD}}$ = 2.0 V to $V_{\text{in}}$	I <sub>SD</sub>		0.07	1.0	μΑ
Output Current In Shutdown Mode, V <sub>out</sub> = 0 V	I <sub>OSD</sub>		0.07	1.0	μΑ
Reverse Bias Protection, Current Flowing from the Output Pin to GND (V <sub>in</sub> = 0 V, V <sub>out_forced</sub> = 2.5 V)	I <sub>OUTR</sub>		10		μΑ

For output current capability for T<sub>J</sub> < 0°C, please refer to Figure 9.</li>
 T<sub>A</sub> must be greater than 0°C.

# $\textbf{ELECTRICAL CHARACTERISTICS - 2.85 V} \ (V_{out} = 2.85 \ V \ typical, \ V_{in} = 3.25 \ V, \ T_{A} = -40 ^{\circ}C \ to \ +85 ^{\circ}C, \ unless \ otherwise \ noted)$

Characteristic	Symbol	Min	Тур	Max	Unit
Output Voltage (Accuracy) $V_{in} = 3.25 \text{ V}$ to 6.85 V, $I_{load} = 0.1 \text{ mA}$ to 500 mA, $T_J = 25^{\circ}\text{C}$	V <sub>out</sub>	-0.9% 2.824	2.85	+0.9% 2.876	V
Output Voltage (Accuracy) $V_{in} = 3.25 \text{ V}$ to 6.85 V, $I_{load} = 0.1 \text{ mA}$ to 500 mA, $T_J = 0^{\circ}\text{C}$ to +85°C	V <sub>out</sub>	-1.4% 2.810	2.85	+1.4% 2.890	V
Output Voltage (Accuracy) (Note 4) $V_{in}=3.25~V~to~6.85~V,~I_{load}=0.1~mA~to~500~mA,~T_{J}=-40^{\circ}C~to~+150^{\circ}C$	V <sub>out</sub>	-1.5% 2.807	2.85	+1.5% 2.893	V
Line Regulation $V_{in} = 3.25 \text{ V to } 12 \text{ V}, I_{load} = 0.1 \text{ mA}$	Line <sub>Reg</sub>		0.04		mV/V
Load Regulation $V_{in} = 3.25 \text{ V}, I_{load} = 0.1 \text{ mA to } 500 \text{ mA}$	Load <sub>Reg</sub>		0.04		mV/mA
Dropout Voltage (See App Note) $I_{load} = 500 \text{ mA}$ $I_{load} = 300 \text{ mA}$ $I_{load} = 50 \text{ mA}$ $I_{load} = 0.1 \text{mA}$	V <sub>DO</sub>			340 230 110 10	mV
Peak Output Current (See Figure 7)	I <sub>pk</sub>	500	700	800	mA
Short Output Current (See Figure 7)	I <sub>sc</sub>			900	mA
Thermal Shutdown	TJ		160		°C
Ground Current In Regulation $I_{load} = 500 \text{ mA (Note 5)}$ $I_{load} = 300 \text{ mA}$ $I_{load} = 50 \text{ mA}$ $I_{load} = 0.1 \text{ mA}$	I <sub>GND</sub>		9.0 4.6 0.8	14 7.5 2.5 190	mA μA
In Dropout $V_{in} = 2.75 \text{ V}$ , $I_{load} = 0.1 \text{ mA}$			-	500	μΑ
In Shutdown SD = 0 V	I <sub>GNDsh</sub>		0.07	1.0	μΑ
Output Noise $C_{nr}$ = 0 nF, $I_{load}$ = 500 mA, f = 10 Hz to 100 kHz, $C_{out}$ = 10 $\mu F$ $C_{nr}$ = 10 nF, $I_{load}$ = 500 mA, f = 10 Hz to 100 kHz, $C_{out}$ = 10 $\mu F$	V <sub>noise</sub>		61 40		μVrms μVrms
Shutdown Threshold Voltage ON Threshold Voltage OFF		2.0		0.4	V
$S_D$ Input Current, $V_{SD}$ = 0 V to 0.4 V or $V_{SD}$ = 2.0 V to $V_{in}$	I <sub>SD</sub>		0.07	1.0	μΑ
Output Current In Shutdown Mode, V <sub>out</sub> = 0 V	I <sub>OSD</sub>		0.07	1.0	μΑ
Reverse Bias Protection, Current Flowing from the Output Pin to GND (V <sub>in</sub> = 0 V, V <sub>out_forced</sub> = 2.85 V)	I <sub>OUTR</sub>		10		μΑ

<sup>4.</sup> For output current capability for T<sub>J</sub> < 0°C, please refer to Figure 8.</li>
5. T<sub>A</sub> must be greater than 0°C.

# $\textbf{ELECTRICAL CHARACTERISTICS - 3.3 V} \ (V_{out} = 3.3 \ V \ typical, \ V_{in} = 3.7 \ V, \ T_{A} = -40^{\circ}C \ to \ +85^{\circ}C, \ unless \ otherwise \ noted)$

Characteristic	Symbol	Min	Тур	Max	Unit
Output Voltage (Accuracy) $V_{in}=3.7$ V to 7.3 V, $I_{load}=0.1$ mA to 500 mA, $T_J=25^{\circ}C$	V <sub>out</sub>	-0.9% 3.270	3.3	+0.9% 3.330	V
Output Voltage (Accuracy) $V_{in} = 3.7 \text{ V to } 7.3 \text{ V, } I_{load} = 0.1 \text{ mA to } 500 \text{ mA, } T_J = 0^{\circ}\text{C to } +85^{\circ}\text{C}$	V <sub>out</sub>	-1.4% 3.254	3.3	+1.4% 3.346	V
Output Voltage (Accuracy) $V_{in} = 3.7 \text{ V to } 7.3 \text{ V, } I_{load} = 0.1 \text{ mA to } 500 \text{ mA, } T_J = -40^{\circ}\text{C to } +150^{\circ}\text{C}$	V <sub>out</sub>	-1.5% 3.250	3.3	+1.5% 3.350	V
Line Regulation $V_{in} = 3.7 \text{ V to } 12 \text{ V}, I_{load} = 0.1 \text{ mA}$	Line <sub>Reg</sub>		0.04		mV/V
Load Regulation $V_{in} = 3.7 \text{ V}, \ I_{load} = 0.1 \text{ mA to } 500 \text{ mA}$	Load <sub>Reg</sub>		0.04		mV/mA
Dropout Voltage (See App Note)  I <sub>load</sub> = 500 mA  I <sub>load</sub> = 300 mA  I <sub>load</sub> = 50 mA  I <sub>load</sub> = 0.1 mA	V <sub>DO</sub>			340 230 110 10	mV
Peak Output Current (See Figure 7)	lpk	500	700	800	mA
Short Output Current (See Figure 7)	I <sub>sc</sub>			900	mA
Thermal Shutdown	TJ		160		°C
Ground Current In Regulation $I_{load} = 500 \text{ mA (Note 6)}$ $I_{load} = 300 \text{ mA}$ $I_{load} = 50 \text{ mA}$ $I_{load} = 0.1 \text{ mA}$	l <sub>GND</sub>		9.0 4.6 0.8	14 7.5 2.5 190	mA μA
In Dropout $V_{in} = 3.2 \text{ V}, I_{load} = 0.1 \text{ mA}$			-	500	μΑ
In Shutdown $S_D = 0 \text{ V}$	I <sub>GNDsh</sub>		0.07	1.0	μΑ
Output Noise $\begin{array}{l} C_{nr}=0 \text{ nF, } I_{load}=500 \text{ mA, } f=10 \text{ Hz to } 100 \text{ kHz, } C_{out}=10  \mu\text{F} \\ C_{nr}=10 \text{ nF, } I_{load}=500 \text{ mA, } f=10 \text{ Hz to } 100 \text{ kHz, } C_{out}=10  \mu\text{F} \end{array}$	V <sub>noise</sub>		69 46		μVrms μVrms
Shutdown Threshold Voltage ON Threshold Voltage OFF		2.0		0.4	V
$S_D$ Input Current, $V_{SD}$ = 0 V to 0.4 V or $V_{SD}$ = 2.0 V to $V_{in}$	I <sub>SD</sub>		0.07	1.0	μΑ
Output Current In Shutdown Mode, V <sub>out</sub> = 0 V	I <sub>OSD</sub>		0.07	1.0	μΑ
Reverse Bias Protection, Current Flowing from the Output Pin to GND $(V_{in} = 0 \text{ V}, V_{out\_forced} = 3.3 \text{ V})$	I <sub>OUTR</sub>		10		μΑ

<sup>6.</sup> T<sub>A</sub> must be greater than 0°C.

# $\textbf{ELECTRICAL CHARACTERISTICS-5.0 V} \ (V_{out} = 5.0 \ V \ typical, \ V_{in} = 5.4 \ V, \ T_{A} = -40 ^{\circ}C \ to \ +85 ^{\circ}C, \ unless \ otherwise \ noted)$

Characteristic	Symbol	Min	Тур	Max	Unit
Output Voltage (Accuracy) $V_{in} = 5.4 \text{ V to } 9.0 \text{ V, } I_{load} = 0.1 \text{ mA to } 500 \text{ mA, } T_J = 25^{\circ}\text{C}$	V <sub>out</sub>	-0.9% 4.955	5.0	+0.9% 5.045	V
Output Voltage (Accuracy) $V_{in} = 5.4 \text{ V to } 9.0 \text{ V}, \text{ I}_{load} = 0.1 \text{ mA to } 500 \text{ mA}, \text{ T}_{J} = 0^{\circ}\text{C to } +85^{\circ}\text{C}$	V <sub>out</sub>	-1.4% 4.930	5.0	+1.4% 5.070	V
Output Voltage (Accuracy) $V_{in} = 5.4 \text{ V to } 9.0 \text{ V, } I_{load} = 0.1 \text{ mA to } 500 \text{ mA, } T_J = -40^{\circ}\text{C to } +150^{\circ}\text{C}$	V <sub>out</sub>	-1.5% 4.925	5.0	+1.5% 5.075	V
Line Regulation $V_{in} = 5.4 \text{ V}$ to 12 V, $I_{load} = 0.1 \text{ mA}$	Line <sub>Reg</sub>		0.04		mV/V
Load Regulation $V_{in} = 5.4 \text{ V}, I_{load} = 0.1 \text{ mA to } 500 \text{ mA}$	Load <sub>Reg</sub>		0.04		mV/mA
Dropout Voltage (See App Note)  I <sub>load</sub> = 500 mA  I <sub>load</sub> = 300 mA  I <sub>load</sub> = 50 mA  I <sub>load</sub> = 0.1 mA	V <sub>DO</sub>			340 230 110 10	mV
Peak Output Current (See Figure 7)	lpk	500	700	830	mA
Short Output Current (See Figure 7)	I <sub>sc</sub>			930	mA
Thermal Shutdown	TJ		160		°C
Ground Current In Regulation I <sub>load</sub> = 500 mA (Note 7) I <sub>load</sub> = 300 mA (Note 7) I <sub>load</sub> = 50 mA I <sub>load</sub> = 50 mA	I <sub>GND</sub>		9.0 4.6 0.8	14 7.5 2.5 190	mA μA
In Dropout $V_{in} = V_{out} -0.1 \text{ V}, I_{load} = 0.1 \text{ mA}$			-	500	μА
In Shutdown $S_D = 0 \text{ V}$	I <sub>GNDsh</sub>		0.07	1.0	μΑ
Output Noise $\begin{array}{l} C_{nr}=0 \text{ nF, } I_{load}=500 \text{ mA, } f=10 \text{ Hz to } 100 \text{ kHz, } C_{out}=10  \mu\text{F} \\ C_{nr}=10 \text{ nF, } I_{load}=500 \text{ mA, } f=10 \text{ Hz to } 100 \text{ kHz, } C_{out}=10  \mu\text{F} \end{array}$	V <sub>noise</sub>		93 58		μVrms μVrms
Shutdown Threshold Voltage ON Threshold Voltage OFF		2.0		0.4	V
$S_D$ Input Current, $V_{SD} = 0$ V to 0.4 V or $V_{SD} = 2.0$ V to $V_{in}$	I <sub>SD</sub>		0.07	1.0	μΑ
Output Current In Shutdown Mode, V <sub>out</sub> = 0 V	I <sub>OSD</sub>		0.07	1.0	μΑ
Reverse Bias Protection, Current Flowing from the Output Pin to GND (V <sub>in</sub> = 0 V, V <sub>out_forced</sub> = 5.0 V)	I <sub>OUTR</sub>		10		μΑ

<sup>7.</sup> T<sub>A</sub> must be greater than 0°C.

# **ELECTRICAL CHARACTERISTICS – Adjustable** ( $V_{out} = 1.25 \text{ V typical}, V_{in} = 2.9 \text{ V}, T_A = -40 ^{\circ}\text{C}$ to +85 $^{\circ}\text{C}$ , unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reference Voltage (Accuracy) $V_{in}$ = 2.9 V to $V_{out}$ + 4.0 V, $I_{load}$ = 0.1 mA to 500 mA, $T_J$ = 25°C	V <sub>ref</sub>	-0.9% 1.239	1.25	+0.9% 1.261	V
Reference Voltage (Accuracy) $V_{in}$ = 2.9 V to $V_{out}$ + 4.0 V, $I_{load}$ = 0.1 mA to 500 mA, $T_J$ = 0°C to +85°C	V <sub>ref</sub>	-1.4% 1.233	1.25	+1.4% 1.268	V
Reference Voltage (Accuracy) (Note 8) $V_{in} = 2.9 \text{ V to V}_{out} + 4.0 \text{ V}, I_{load} = 0.1 \text{ mA to } 500 \text{ mA}, T_J = -40^{\circ}\text{C to } +150^{\circ}\text{C}$	V <sub>ref</sub>	-1.5% 1.231	1.25	+1.5% 1.269	V
Line Regulation $V_{in} = 2.9 \text{ V to } 12 \text{ V, } I_{load} = 0.1 \text{ mA}$	Line <sub>Reg</sub>		0.04		mV/V
Load Regulation $V_{in} = 2.9 \text{ V}, I_{load} = 0.1 \text{ mA to } 500 \text{ mA}$	Load <sub>Reg</sub>		0.04		mV/mA
Dropout Voltage (See App Note), $V_{out} = 2.5 \text{ V}$ to 10 V $I_{load} = 500 \text{ mA}$ (Note 9) $I_{load} = 300 \text{ mA}$ $I_{load} = 50 \text{ mA}$ $I_{load} = 0.1 \text{ mA}$	V <sub>DO</sub>			340 230 110 10	mV
Peak Output Current (Note 9) (See Figure 7)	lpk	500	700	860	mA
Short Output Current (See Figure 7) $ \begin{array}{c} V_{out} \leq 3.3 \ V \\ V_{out} > 3.3 \ V \end{array} $	I <sub>sc</sub>			900 990	mA
Thermal Shutdown	TJ		160		°C
Ground Current In Regulation I <sub>load</sub> = 500 mA (Note 9) I <sub>load</sub> = 300 mA (Note 9) I <sub>load</sub> = 50 mA I <sub>load</sub> = 50 mA	I <sub>GND</sub>		9.0 4.6 0.8	14 7.5 2.5 190	mA μA
In Dropout $V_{in} = V_{out} -0.1 \text{ V}, I_{load} = 0.1 \text{ mA}$			-	500	μΑ
In Shutdown $S_D = 0 \text{ V}$	I <sub>GNDsh</sub>		0.07	1.0	μΑ
Output Noise $C_{nr}=0$ nF, $I_{load}=500$ mA, f = 10 Hz to 100 kHz, $C_{out}=10$ $\mu\text{F}$ $C_{nr}=10$ nF, $I_{load}=500$ mA, f = 10 Hz to 100 kHz, $C_{out}=10$ $\mu\text{F}$	V <sub>noise</sub>		38 26		μVrms μVrms
Shutdown Threshold Voltage ON Threshold Voltage OFF		2.0		0.4	V
$S_D$ Input Current, $V_{SD}$ = 0 V to 0.4 V or $V_{SD}$ = 2.0 V to $V_{in}$ $V_{in} \leq 5.4 \ V_{in} > 5.4 \ V_$	I <sub>SD</sub>		0.07	1.0 5.0	μΑ
Output Current In Shutdown Mode, V <sub>out</sub> = 0 V	I <sub>OSD</sub>		0.07	1.0	μΑ
Reverse Bias Protection, Current Flowing from the Output Pin to GND $(V_{in} = 0 \text{ V}, V_{out\_forced} = V_{out} \text{ (nom)} \le 7 \text{ V}) \text{ (Note 10)}$	I <sub>OUTR</sub>		1.0		μΑ

<sup>8.</sup> For output current capability for  $T_J < 0^{\circ}C$ , please refer to Figure 9. 9.  $T_A$  must be greater than  $0^{\circ}C$ . 10. Reverse bias protection feature valid only if  $V_{out} - V_{in} \le 7 \text{ V}$ .

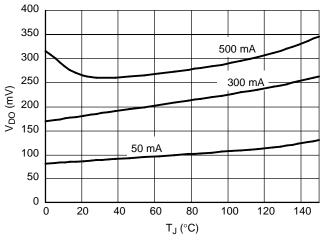


Figure 3. Dropout Voltage vs. Temperature

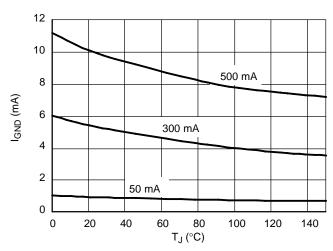


Figure 4. Ground Current vs. Temperature

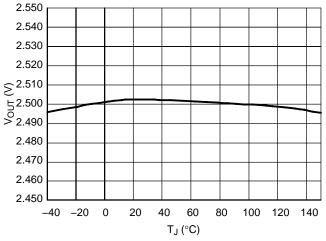


Figure 5. Output Voltage vs. Temperature

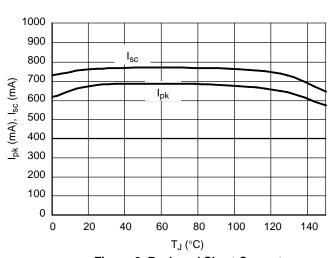


Figure 6. Peak and Short Current vs. Temperature

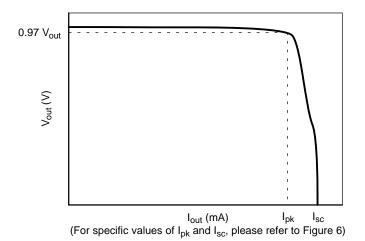


Figure 7. Output Voltage vs. Output Current

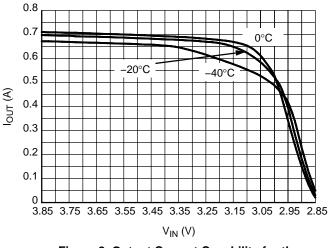


Figure 8. Output Current Capability for the 2.85 V Version

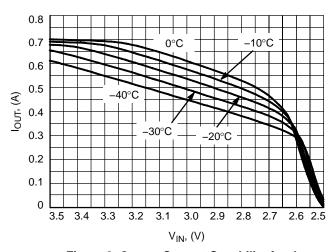


Figure 9. Output Current Capability for the 2.5 V Version

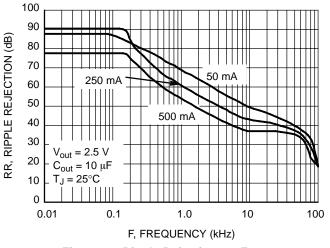


Figure 10. Ripple Rejection vs. Frequency

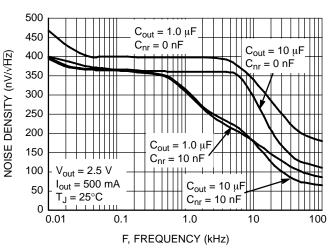


Figure 11. Output Noise Density

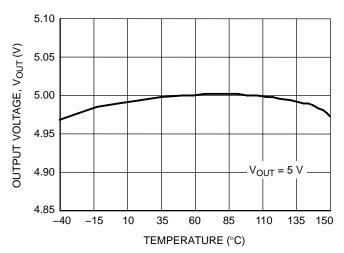


Figure 12. Output Voltage vs. Temperature

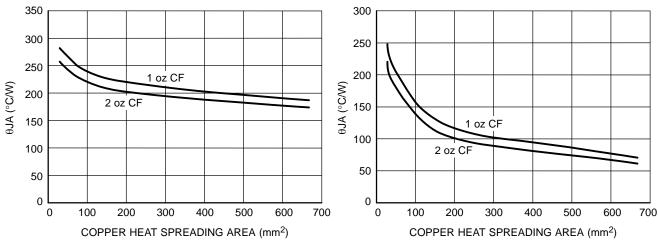


Figure 13. Micro 8 Self Heating Thermal Characteristic as a Function of Copper Area on the PCB

Figure 14. DFN 10 Self Heating Thermal Characteristic as a Function of Copper Area on the PCB

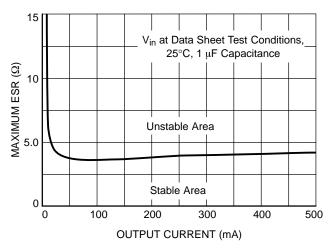


Figure 15. Stability with ESR vs. lout

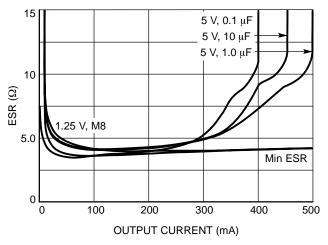


Figure 16. Output Current vs. ESR

# **APPLICATIONS INFORMATION**

# **Reverse Bias Protection**

Reverse bias is a condition caused when the input voltage goes to zero, but the output voltage is kept high either by a large output capacitor or another source in the application which feeds the output pin.

Normally in a bipolar LDO all the current will flow from the output pin to input pin through the PN junction with limited current capability and with the potential to destroy the IC.

Due to an improved architecture, the NCP3335A can withstand up to 7.0 V on the output pin with virtually no current flowing from output pin to input pin, and only negligible amount of current (tens of  $\mu A$ ) flowing from the output pin to ground for infinite duration.

# **Input Capacitor**

An input capacitor of at least  $1.0~\mu F$ , any type, is recommended to improve the transient response of the regulator and/or if the regulator is located more than a few inches from the power source. It will also reduce the circuit's sensitivity to the input line impedance at high frequencies. The capacitor should be mounted with the shortest possible track length directly across the regular's input terminals.

# **Output Capacitor**

The NCP3335A remains stable with any type of capacitor as long as it fulfills its 1.0  $\mu$ F requirement. There are no constraints on the minimum ESR and it will remain stable up to an ESR of 5.0  $\Omega$ . Larger capacitor values will improve the noise rejection and load transient response.

#### **Noise Reduction Pin**

Output noise can be greatly reduced by connecting a 10 nF capacitor ( $C_{nr}$ ) between the noise reduction pin and ground (see Figure 1). In applications where very low noise is not required, the noise reduction pin can be left unconnected.

For the adjustable version, in addition to the 10 nF  $C_{nr}$ , a 68 pF capacitor connected in parallel with R1 (see Figure 2)

is recommended to further reduce output noise and improve stability.

# **Adjustable Operation**

The output voltage can be set by using a resistor divider as shown in Figure 2 with a range of 1.25 to 10 V. The appropriate resistor divider can be found by solving the equation below. The recommended current through the resistor divider is from 10  $\mu A$  to 100  $\mu A$ . This can be accomplished by selecting resistors in the  $k\Omega$  range. As result, the  $I_{adj}*R2$  becomes negligible in the equation and can be ignored.

$$V_{out} = 1.25 * (1 + \frac{R1}{R2}) + I_{adj} * R2$$
 (eq. 1)

Example:

For  $V_{out} = 2.9$  V, can use  $R_1 = 36$  k $\Omega$  and  $R_2 = 27$  k $\Omega$ .

$$1.25 * \left(1 + \frac{36 \text{ k}\Omega}{27 \text{ k}\Omega}\right) = 2.91 \text{ V}$$
 (eq. 2)

# **Dropout Voltage**

The voltage dropout is measured at 97% of the nominal output voltage.

#### **Thermal Considerations**

Internal thermal limiting circuitry is provided to protect the integrated circuit in the event that the maximum junction temperature is exceeded. This feature provides protection from a catastrophic device failure due to accidental overheating. This protection feature is not intended to be used as a substitute to heat sinking. The maximum power that can be dissipated, can be calculated with the equation below:

$$P_{D} = \frac{T_{J}(max) - T_{A}}{R_{\theta J}A}$$
 (eq. 3)

For improved thermal performance, contact the factory for the DFN package option. The DFN package includes an exposed metal pad that is specifically designed to reduce the junction to air thermal resistance,  $R_{\theta JA}$ .

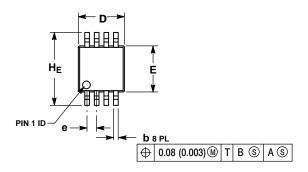
# **ORDERING INFORMATION**

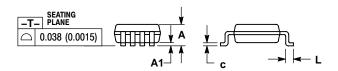
Device	Nominal Output Voltage	Package	Shipping <sup>†</sup>
NCP3335ADM250R2G	2.5 V	Micro8 (Pb-Free)	4000 / Tape & Reel
NCP3335ADM285R2G	2.85 V	Micro8 (Pb-Free)	4000 / Tape & Reel
NCP3335ADM330R2G	3.3 V	Micro8 (Pb-Free)	4000 / Tape & Reel
NCP3335ADM500R2G	5.0 V	Micro8 (Pb-Free)	4000 / Tape & Reel
NCP3335ADMADJR2G	Adj.	Micro8 (Pb-Free)	4000 / Tape & Reel
NCP3335AMN250R2G	2.5 V	DFN10 (Pb-Free)	3000 / Tape & Reel
NCP3335AMN285R2G	2.85 V	DFN10 (Pb-Free)	3000 / Tape & Reel
NCP3335AMN330R2G	3.3 V	DFN10 (Pb-Free)	3000 / Tape & Reel
NCP3335AMN500R2G	5.0 V	DFN10 (Pb-Free)	3000 / Tape & Reel
NCP3335AMNADJR2G	Adj.	DFN10 3000 / Tape & Reel (Pb-Free)	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
\*Please contact factory for other voltage options.

# **PACKAGE DIMENSIONS**

# Micro8 CASE 846A-02 ISSUE G

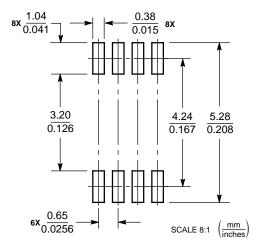




- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  4. DIMENSION R DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
- DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
   INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
   846A-01 OBSOLETE, NEW STANDARD 846A-02.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	MOM	MAX
Α			1.10			0.043
A1	0.05	0.08	0.15	0.002	0.003	0.006
b	0.25	0.33	0.40	0.010	0.013	0.016
С	0.13	0.18	0.23	0.005	0.007	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	2.90	3.00	3.10	0.114	0.118	0.122
е	0.65 BSC			0.026 BSC		
L	0.40	0.55	0.70	0.016	0.021	0.028
HE	4.75	4.90	5.05	0.187	0.193	0.199

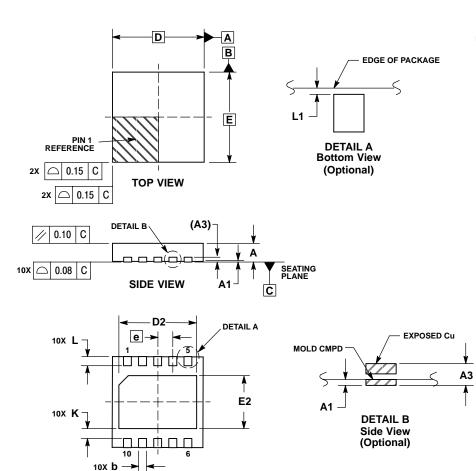
# **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### PACKAGE DIMENSIONS

# DFN10 CASE 485C-01 **ISSUE A**



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS. DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
- TERMINAL b MAY HAVE MOLD COMPOUND MATERIAL ALONG SIDE EDGE. MOLD FLASHING MAY NOT EXCEED 30 MICRONS ONTO BOTTOM SURFACE OF TERMINAL b. DETAILS A AND B SHOW OPTIONAL VIEWS
- FOR END OF TERMINAL LEAD AT EDGE OF PACKAGE.

	MILLIMETERS				
DIM	MIN	MAX			
Α	0.80	1.00			
A1	0.00	0.05			
A3	0.20 REF				
b	0.18	0.30			
D	3.00 BSC				
D2	2.45	2.55			
Е	3.00 BSC				
E2	1.75	1.85			
е	0.50 BSC				
K	0.19 TYP				
L	0.35	0.45			
L1	0.00	0.03			

The products described herein NCP3335A, may be covered by one or more of the following U.S. patents; 5,920,184, 5,966,004, and 5,834,926. There may be other patents pending.

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